

INFORMATION DISCLOSURE CITATION

Docket: 461568-014

S r. No. 09/689 131

Applicant: John M. Hetzel, Jr.

Filed: 10/12/00

Group: 3741

JAN 22 2001

U.S. PATENT DOCUMENTS

Examiner	Document No.	Date	Name	Class	Sub	
SS	2,351,235	6/44	Shroyer et al.	2	6	
	4,184,212	1/80	Bowman	2	5	
	4,820,568	4/89	Harpell et al.	428	113	
	4,932,076	6/90	Giorgio et al.	2	5	
	5,018,220	5/91	Lane et al.	428	143	
	5,110,655	5/92	Engler et al.	428	109	
	5,160,776	11/92	Li et al.	428	113	
	5,330,820	7/94	Li et al.	89	36.05	
	5,349,893	9/94	Dunn	428	113	
	5,480,706	1/96	Li et al.	2	5	
	5,517,691	5/96	Blake	2	410	
	5,661,854	9/97	March, II	2	410	
	5,794,270	8/98	Howat	264	255	
SS	6,010,656	1/00	Nomura et al.			

FOREIGN PATENT DOCUMENTS

Trans

Examiner	Document No.	Date	Country	Class	Sub	Y	N

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

SS		Advertising Literature: Part Cost Reduction, Ceram Technologies Corporation, 1993
Examiner: <i>John Hetzel</i> Date Considered: <i>5/31/02</i>		

* Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation is not in conformance and not considered. Include copy of this form with next communication to applicant.

INFORMATION DISCLOSURE CITATION



Docket: 520219-273

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Applicant: John M. Hetzel, Jr.

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U.S. PATENT DOCUMENTS

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Examiner	Document No.	Date	Name	Class	Sub
SS	6,211,305	04/2001	Hsu et al.		
SS	6,098,197	08/2000	Hetzel, Jr. et al.		

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FOREIGN PATENT DOCUMENT

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Examiner		Document No.	Date	Country	Class	Sub	Y	N	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

Examiner: <i>John J. J. J.</i>	Date Considered: <i>5/31/02</i>

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